BAP64Q

Quad PIN diode attenuator

Rev. 1 — 7 October 2010

Product data sheet

1. Product profile

1.1 General description

Quad PIN diode in a SOT753 package.

1.2 Features and benefits

- 4 PIN diodes in a SOT753 package
- 300 kHz to 4 GHz
- High linearity
- Low insertion loss
- reduction in part count
- Low diode capacitance
- Low diode forward resistance

1.3 Applications

- RF attenuators
- Broadband system applications
- General purpose Voltage Controlled Attenuators for high linearity applications

2. Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	RF in	D- D.	_
2	series bias	5 4	5 4
3	RF out		\frac{\psi}{2} \cdot \frac{\psi}{2} \rightarrow
4	shunt 1 bias	1 2 3	
5	shunt 2 bias		1 2 3 sym143

3. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
BAP64Q	SC-74A	plastic surface-mounted package; 5 leads	SOT753	



NXP Semiconductors

BAP64Q

Quad PIN diode attenuator

4. Marking

Table 3. Marking

Type number	Marking code
BAP64Q	A1

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{R}	reverse voltage		[1]	-	100	V
l _F	forward current		[1]	-	100	mA
P _{tot}	total power dissipation	T _{sp} = 90 °C	[1]	-	125	mW
T _{stg}	storage temperature			-65	+150	°C
Tj	junction temperature			-65	+150	°C

^[1] single diode.

6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		350	K/W

7. Characteristics

Table 6. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	ı	Min	Тур	Max	Unit
Per diod	e						
V_{F}	forward voltage	I _F = 50 mA	-	•	0.95	1.1	V
I _R	reverse current	V _R = 20 V	-	•	-	1	μΑ
		V _R = 100 V	-	•	-	10	μΑ
C_{d}	diode capacitance	f = 1 MHz; see Figure 1					
		$V_R = 0 V$	-	-	0.52	-	pF
		V _R = 1 V	-	•	0.37	-	pF
		V _R = 20 V	-	•	0.23	0.35	pF
r _D	diode forward resistance	f = 100 MHz; see Figure 2					
		$I_F = 0.5 \text{ mA}$	<u>[1]</u> -	•	20	40	Ω
		I _F = 1 mA	<u>[1]</u> -	•	10	20	Ω
		I _F = 10 mA	<u>[1]</u> -	•	2	3.8	Ω
		I _F = 100 mA	<u>[1]</u> -	•	0.7	1.35	Ω
τ∟	charge carrier life time	when switched from I_F = 10 mA to I_R = 6 mA; R_L = 100 Ω ; measured at I_R = 3 mA	-	-	1.55	-	μS

[1] Guaranteed on AQL basis: inspection level S4, AQL 1.0.

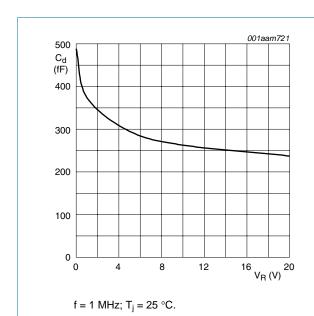


Fig 1. Diode capacitance as a function of reverse voltage; typical values.

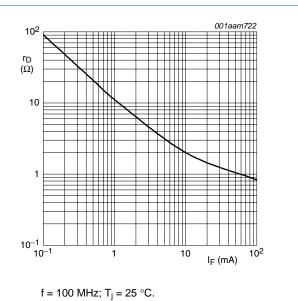


Fig 2. Diode forward resistance as a function of forward current; typical values.

8. Application information

8.1 Application circuit

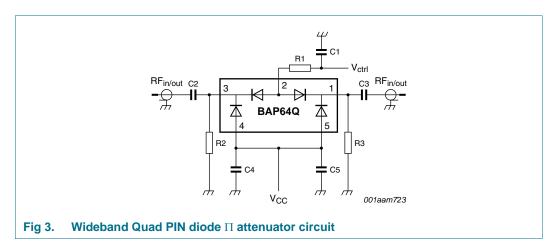


Table 7. List of components used for the typical application

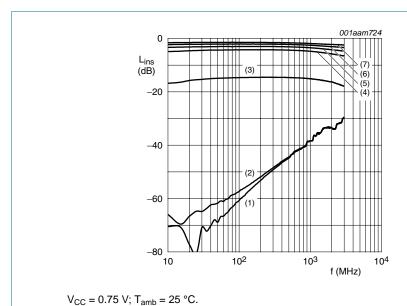
Component	Description	Value
C1, C2, C3, C4, C5	chip capacitor	10 nF
R1, R2, R3	chip resistor	1000 Ω

8.2 Quad PIN pi attenuator characteristics

Table 8. Typical performance for BAP64Q quad PIN diode Π attenuator

 $V_{\rm CC}$ = 0.75 V; T_{amb} = 25 °C unless otherwise specified.

~~	477.0	•		
Symbol	Parameter	Test Conditions	Тур	Units
L _{ins}	insertion loss	$V_{ctrl} = 10 \text{ V}; f = 1 \text{ GHz}$	1.8	dB
RLin	input return loss	$V_{ctrl} = 0 V; f = 1 GHz$	18	dB
α	attenuation	$V_{ctrl} = 0 V; f = 1 GHz$	38	dB
IP3 _i	input third-order intercept point	f = 0.1 GHz		
		$V_{ctrl} = 2 V$	32	dBm
		$V_{ctrl} = 10 \text{ V}$	42	dBm
		f = 0.9 GHz		
		$V_{ctrl} = 2 V$	40	dBm
		$V_{ctrl} = 10 \text{ V}$	41	dBm
		f = 1.8 GHz		
		$V_{ctrl} = 2 V$	40	dBm
		$V_{ctrl} = 10 \text{ V}$	37	dBm
		f = 2.1 GHz		
		$V_{ctrl} = 2 V$	38	dBm
		V _{ctrl} = 10 V	39	dBm

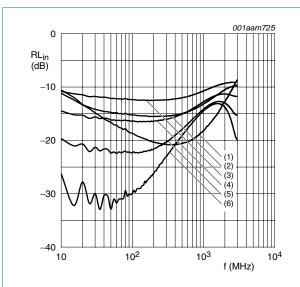


VCC = 0.75 V, Tamb = 25

- (1) $V_{ctrl} = 0 V$
- (2) $V_{ctrl} = 0.5 \text{ V}$
- (3) $V_{ctrl} = 1 V$
- (4) $V_{ctrl} = 2 V$
- (5) $V_{ctrl} = 3 V$
- (6) $V_{ctrl} = 5 \text{ V}$
- (7) $V_{ctrl} = 10 \text{ V}$

Fig 4. Insertion loss as function of frequency; typical values

Quad PIN diode attenuator



 V_{CC} = 0.75 V; T_{amb} = 25 °C.

(1)
$$V_{ctrl} = 0 V$$

(2)
$$V_{ctrl} = 1 V$$

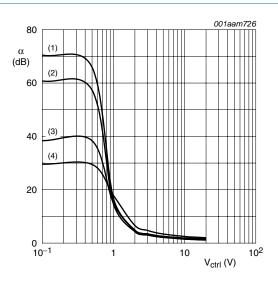
(3)
$$V_{ctrl} = 2 V$$

(4)
$$V_{ctrl} = 3 V$$

(5)
$$V_{ctrl} = 5 V$$

(6)
$$V_{ctrl} = 10 \text{ V}$$

Fig 5. Return loss as function of frequency; typical values



 V_{CC} = 0.75 V; T_{amb} = 25 °C.

(1)
$$f = 10 \text{ MHz}$$

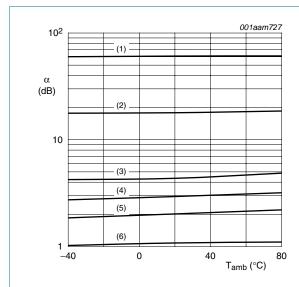
(2)
$$f = 100 \text{ MHz}$$

(3)
$$f = 1000 \text{ MHz}$$

(4)
$$f = 3000 \text{ MHz}$$

Fig 6. Attenuation as function of control voltage; typical values

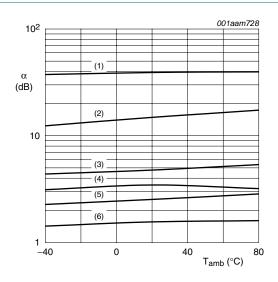
Quad PIN diode attenuator



 $V_{CC} = 0.75 \text{ V}$; f = 100 MHz.

- (1) $V_{ctrl} = 0 V$
- (2) $V_{ctrl} = 1 V$
- (3) $V_{ctrl} = 2 V$
- (4) $V_{ctrl} = 3 V$
- (5) $V_{ctrl} = 5 V$
- (6) $V_{ctrl} = 10 \text{ V}$

Fig 7. Attenuation as function of temperature; typical values



 $V_{CC} = 0.75 \text{ V}; f = 1000 \text{ MHz}.$

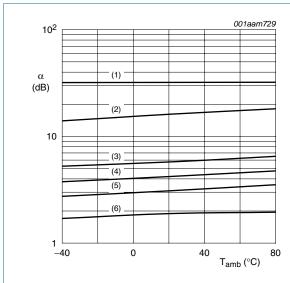
- (1) $V_{ctrl} = 0 V$
- (2) $V_{ctrl} = 1 V$
- (3) $V_{ctrl} = 2 V$
- $(4) \quad V_{ctrl} = 3 \text{ V}$
- (5) $V_{ctrl} = 5 V$
- (6) $V_{ctrl} = 10 \text{ V}$

Fig 8. Attenuation as function of temperature; typical values

NXP Semiconductors

BAP64Q

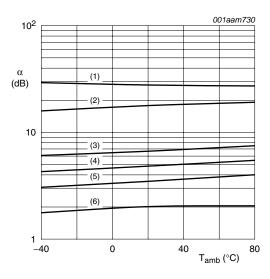
Quad PIN diode attenuator



 $V_{CC} = 0.75 \text{ V}$; f = 2000 MHz.

- (1) $V_{ctrl} = 0 V$
- (2) $V_{ctrl} = 1 V$
- (3) $V_{ctrl} = 2 V$
- (4) $V_{ctrl} = 3 V$
- (5) $V_{ctrl} = 5 V$
- (6) $V_{ctrl} = 10 \text{ V}$

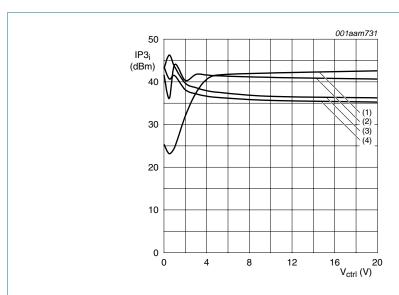
Fig 9. Attenuation as function of temperature; typical values



 $V_{CC} = 0.75 \text{ V}$; f = 3000 MHz.

- (1) $V_{ctrl} = 0 V$
- (2) $V_{ctrl} = 1 V$
- (3) $V_{ctrl} = 2 V$
- (4) $V_{ctrl} = 3 V$
- (5) $V_{ctrl} = 5 V$
- (6) $V_{ctrl} = 10 \text{ V}$

Fig 10. Attenuation as function of temperature; typical values



 $V_{CC} = 0.75 \text{ V}; T_{amb} = 25 \text{ °C}.$

- (1) f = 100 MHz
- (2) f = 900 MHz
- (3) f = 1800 MHz
- (4) f = 2100 MHz

Fig 11. Input third-order intercept point as control voltage; typical values

9. Package outline

Plastic surface-mounted package; 5 leads

SOT753

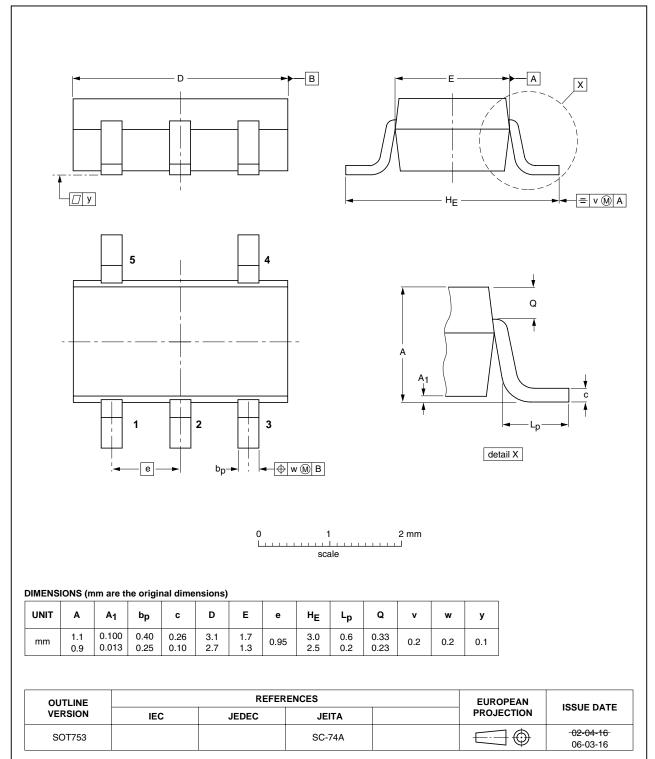


Fig 12. Package outline SOT753

BAP64Q

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2010. All rights reserved.

NXP Semiconductors

BAP64Q

Quad PIN diode attenuator

10. Abbreviations

Table 9. Abbreviations

Acronym	Description
AQL	Acceptable Quality Level
PIN	P-type, Intrinsic, N-type
RF	Radio Frequency
S4	Special inspection level 4

11. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP64Q v.1	20101007	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

12.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

12.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

BAP64Q

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2010. All rights reserved.

NXP Semiconductors BAP64Q

Quad PIN diode attenuator

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

12.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

13. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

NXP Semiconductors



Quad PIN diode attenuator

14. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications
2	Pinning information 1
3	Ordering information 1
4	Marking 2
5	Limiting values 2
6	Thermal characteristics 2
7	Characteristics 3
8	Application information 4
8.1	Application circuit
8.2	Quad PIN pi attenuator characteristics 5
9	Package outline
10	Abbreviations
11	Revision history
12	Legal information
12.1	Data sheet status
12.2	Definitions
12.3	Disclaimers
12.4	Trademarks12
13	Contact information 12
14	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.